BZT5250H-Q series

Low-current voltage regulator diodes

Rev. 2 — 18 July 2024 Product data sheet

1. General description

General-purpose Zener diodes in an SOD123F small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Total power dissipation: ≤ 830 mW
- Two tolerance series: ±2 % and approximately ±5 %
- Working voltage range: nominal 1.8 V to 51 V (E24 range)
- Specified at a low test current (50 µA), ideal for low bias and portable battery-powered applications
- Small plastic package suitable for surface-mounted design
- BZT5250H-B11-Q to -C51-Q: Intentional minor rise of leakage current for optimized fast switching and noise reduction [AN90031]
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Low-current general regulation functions

4. Quick reference data

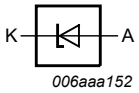
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_F	forward voltage	I_F = 10 mA	[1]	-	-	0.9	V
P_{tot}	total power dissipation	T_{amb} ≤ 25 °C	[2]	-	-	375	mW
			[3]	-	-	830	mW

[1] Pulse test: t_p ≤ 300 µs; δ ≤ 0.02.
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description		Simplified outline	Graphic symbol
1	K	cathode	[1]		
2	A	anode			

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BZT5250H-Q series	-	plastic, surface-mounted package; 2 leads; 2.6 mm x 1.6 mm x 1.1 mm body	SOD123F

7. Marking

Table 4. Marking Codes

Type number	Marking code	Type number	Marking code	Type number	Marking code	Type number	Marking code
BZT5250H-B1V8-Q	U9	BZT5250H-B10-Q	W9	BZT5250H-C1V8-Q	X3	BZT5250H-C10-Q	XM
BZT5250H-B2V0-Q	V1	BZT5250H-B11-Q	WA	BZT5250H-C2V0-Q	X4	BZT5250H-C11-Q	XN
BZT5250H-B2V2-Q	V2	BZT5250H-B12-Q	WB	BZT5250H-C2V2-Q	X5	BZT5250H-C12-Q	XP
BZT5250H-B2V4-Q	V3	BZT5250H-B13-Q	WC	BZT5250H-C2V4-Q	X6	BZT5250H-C13-Q	XQ
BZT5250H-B2V7-Q	V4	BZT5250H-B15-Q	WD	BZT5250H-C2V7-Q	X7	BZT5250H-C15-Q	XR
BZT5250H-B3V0-Q	V5	BZT5250H-B16-Q	WF	BZT5250H-C3V0-Q	X8	BZT5250H-C16-Q	XS
BZT5250H-B3V3-Q	V6	BZT5250H-B18-Q	WH	BZT5250H-C3V3-Q	X9	BZT5250H-C18-Q	XT
BZT5250H-B3V6-Q	V7	BZT5250H-B20-Q	WJ	BZT5250H-C3V6-Q	XA	BZT5250H-C20-Q	XU
BZT5250H-B3V9-Q	V8	BZT5250H-B22-Q	WL	BZT5250H-C3V9-Q	XB	BZT5250H-C22-Q	XV
BZT5250H-B4V3-Q	V9	BZT5250H-B24-Q	WN	BZT5250H-C4V3-Q	XC	BZT5250H-C24-Q	Y1
BZT5250H-B4V7-Q	W1	BZT5250H-B27-Q	WQ	BZT5250H-C4V7-Q	XD	BZT5250H-C27-Q	Y5
BZT5250H-B5V1-Q	W2	BZT5250H-B30-Q	WS	BZT5250H-C5V1-Q	XE	BZT5250H-C30-Q	Y6
BZT5250H-B5V6-Q	W3	BZT5250H-B33-Q	WU	BZT5250H-C5V6-Q	XF	BZT5250H-C33-Q	Y7
BZT5250H-B6V2-Q	W4	BZT5250H-B36-Q	WV	BZT5250H-C6V2-Q	XG	BZT5250H-C36-Q	Y8
BZT5250H-B6V8-Q	W5	BZT5250H-B39-Q	23	BZT5250H-C6V8-Q	XH	BZT5250H-C39-Q	Y9
BZT5250H-B7V5-Q	W6	BZT5250H-B43-Q	WX	BZT5250H-C7V5-Q	XJ	BZT5250H-C43-Q	Z2
BZT5250H-B8V2-Q	W7	BZT5250H-B47-Q	WY	BZT5250H-C8V2-Q	XK	BZT5250H-C47-Q	ZQ
BZT5250H-B9V1-Q	W8	BZT5250H-B51-Q	X2	BZT5250H-C9V1-Q	XL	BZT5250H-C51-Q	ZX

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
I_F	forward current			-	200	mA
P_{ZSM}	non-repetitive peak reverse power dissipation	t_p = 100 µs; square wave; T_j = 25 °C; prior to surge		-	40	W
P_{tot}	total power dissipation	T_{amb} ≤ 25 °C	[1]	-	375	mW
			[2]	-	830	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	+150	°C
T_{stg}	storage temperature			-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	330	K/W
			[2]	-	-	150	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	70	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.
[3] Soldering point of cathode tab.

10. Characteristics

Table 7. Electrical characteristics

T_j = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Max	Unit
V_F	forward voltage	I_F = 10 mA	[1]	0.9	V

[1] Pulse test: t_p ≤ 300 µs; δ ≤ 0.02

Table 8. Electrical characteristics per type: BZT5250H-B1V8-Q to BZT5250H-C36-Q

T_j = 25 °C unless otherwise specified.

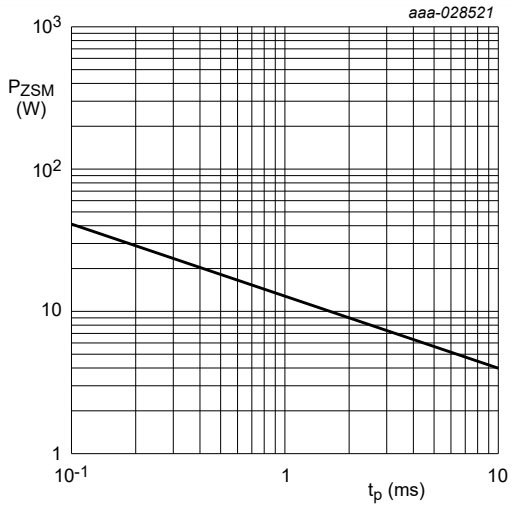
BZT5250H-xxx-Q	Sel.	Working voltage V_Z (V)		Differential resistance r_{diff} (Ω)		Reverse current I_R (µA)		Temperature coefficient S_Z (mV/K)		Diode capacitance C_d (pF)
		I_Z = 50 µA		I_Z = 1 mA	I_Z = 5 mA			I_Z = 5 mA		f = 1 MHz V_R = 0 V
		Min	Max	Max	Max	Max	V_R (V)	Min	Max	Max
1V8	B	1.76	1.84	600	100	7.5	1.0	-3.5	0	220
	C	1.71	1.89							
2V0	B	1.96	2.04	600	100	7	1.0	-3.5	0	220
	C	1.88	2.12							
2V2	B	2.15	2.25	600	100	4	1.0	-3.5	0	210
	C	2.09	2.31							
2V4	B	2.35	2.45	600	100	2	1.0	-3.5	0	200
	C	2.28	2.52							
2V7	B	2.65	2.75	600	100	1	1.0	-3.5	0	190
	C	2.565	2.835							
3V0	B	2.94	3.06	600	100	0.8	1.0	-3.5	0.2	170
	C	2.85	3.15							
3V3	B	3.23	3.37	600	100	7.5	1.5	-3.5	1.2	160
	C	3.13	3.47							
3V6	B	3.53	3.67	600	95	7.5	2.0	-3.5	1.2	160
	C	3.42	3.78							
3V9	B	3.82	3.98	600	95	5.0	2.0	-2.7	2.5	150
	C	3.70	4.10							
4V3	B	4.21	4.39	600	95	4.0	2.0	-2.7	2.5	150
	C	4.09	4.52							
4V7	B	4.61	4.79	600	80	5.0	3.0	-2.7	2.5	140
	C	4.47	4.94							
5V1	B	5.00	5.20	500	60	5.0	3.0	-2.0	3.7	130
	C	4.85	5.36							
5V6	B	5.49	5.71	400	40	2.0	4.0	-2.0	3.7	120
	C	5.32	5.88							
6V2	B	6.08	6.32	160	10	1.0	5.0	0.4	4.5	110
	C	5.89	6.51							
6V8	B	6.66	6.94	80	15	0.1	5.1	1.2	4.5	100
	C	6.46	7.14							
7V5	B	7.35	7.65	80	15	0.1	5.7	2.5	5.3	150
	C	7.13	7.88							
8V2	B	8.04	8.36	80	15	0.1	6.2	3.2	6.2	150
	C	7.79	8.61							
9V1	B	8.92	9.28	100	15	0.1	6.9	3.8	7.0	150
	C	8.65	9.56							
10	B	9.80	10.20	150	20	0.1	7.6	4.5	8.0	90
	C	9.50	10.50							

BZT5250H-xxx-Q	Sel.	Working voltage V_Z (V)		Differential resistance r_{diff} (Ω)		Reverse current I_R (μA)		Temperature coefficient S_Z (mV/K)		Diode capacitance C_d (pF)
		I_Z = 50 μA		I_Z = 1 mA	I_Z = 5 mA			I_Z = 5 mA		f = 1 MHz V_R = 0 V
		Min	Max	Max	Max	Max	V_R (V)	Min	Max	Max
11	B	10.80	11.20	150	20	0.05	8.4	5.4	9.0	85
	C	10.45	11.55							
12	B	11.80	12.20	150	25	0.05	9.1	6.0	10	85
	C	11.40	12.60							
13	B	12.70	13.30	170	30	0.05	9.8	7.0	11	80
	C	12.35	13.65							
15	B	14.70	15.30	200	30	0.05	11.4	9.2	13	75
	C	14.25	15.75							
16	B	15.70	16.30	200	40	0.05	12.1	10.4	14	75
	C	15.20	16.80							
18	B	17.60	18.40	225	45	0.05	13.6	12.4	16	70
	C	17.10	18.90							
20	B	19.60	20.40	225	55	0.05	15.2	14.4	18	60
	C	19.00	21.00							
22	B	21.60	22.40	250	55	0.05	16.7	16.4	20	60
	C	20.90	23.10							
24	B	23.50	24.50	250	70	0.05	18.2	18.4	22	55
	C	22.80	25.20							
27	B	26.50	27.50	300	80	0.05	20.4	21.4	25.3	50
	C	25.65	28.35							
30	B	29.40	30.60	300	80	0.05	22.8	24.4	29.4	50
	C	28.50	31.50							
33	B	32.30	33.70	325	80	0.05	25.0	27.4	33.4	45
	C	31.35	34.65							
36	B	35.30	36.70	350	90	0.05	27.3	30.4	37.4	45
	C	34.20	37.80							

Table 9. Electrical characteristics per type: BZT5250H-B39-Q to BZT5250H-C51-Q

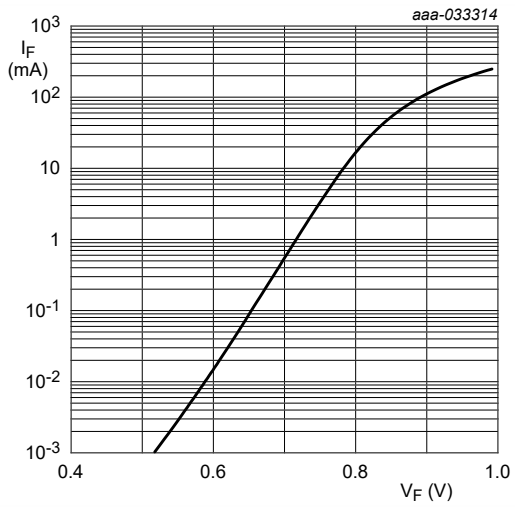
T_j = 25 °C unless otherwise specified.

BZT5250H-xxx-Q	Sel.	Working voltage V_Z (V)		Differential resistance r_{diff} (Ω)		Reverse current I_R (μA)		Temperature coefficient S_Z (mV/K)		Diode capacitance C_d (pF)
		I_Z = 50 μA		I_Z = 0.5 mA	I_Z = 2 mA			I_Z = 2 mA		f = 1 MHz V_R = 0 V
		Min	Max	Max	Max	Max	V_R (V)	Min	Max	Max
39	B	38.20	39.80	350	130	0.05	29.6	33.4	41.2	45
	C	37.05	40.95							
43	B	42.10	43.90	375	150	0.05	32.6	37.6	46.6	40
	C	40.85	45.15							
47	B	46.10	47.90	375	170	0.05	32.9	42.0	51.8	40
	C	44.00	50.00							
51	B	50.00	52.00	400	180	0.05	35.7	46.6	57.2	40
	C	48.00	54.00							



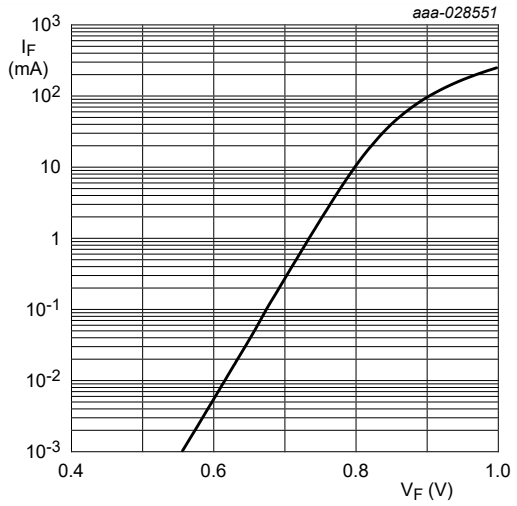
T_j = 25 °C (before surge)

Fig. 1. Non-repetitive peak reverse power dissipation as a function of pulse duration; maximum values



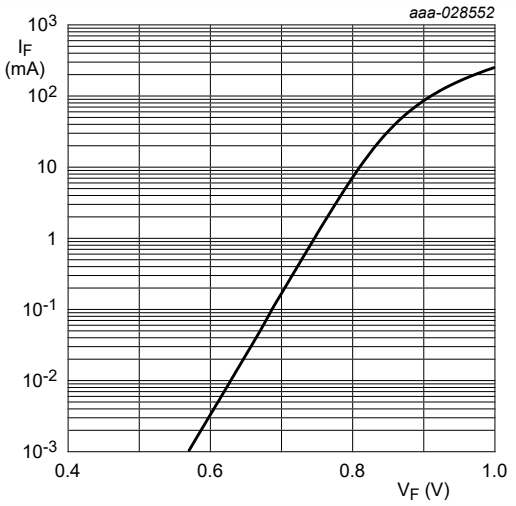
T_j = 25 °C

Fig. 2. Forward current as a function of forward voltage; typical values (BZT5250H-B/C1V8-Q)



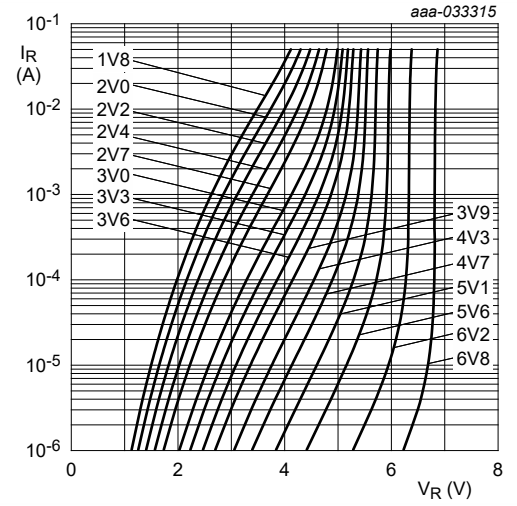
T_j = 25 °C

Fig. 3. Forward current as a function of forward voltage; typical values (BZT5250H-B/C6V8-Q)



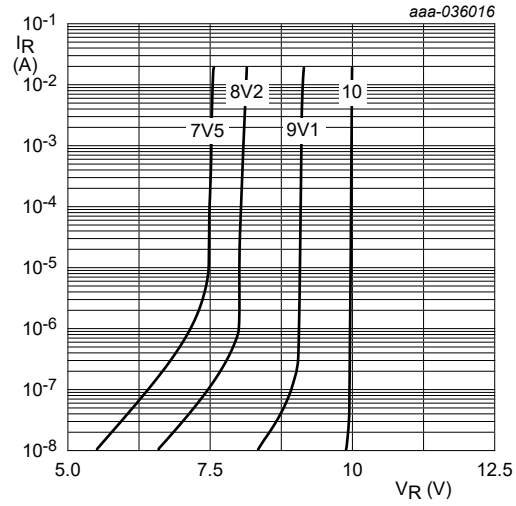
T_j = 25 °C

Fig. 4. Forward current as a function of forward voltage; typical values (BZT5250H-B/C7V5-Q)



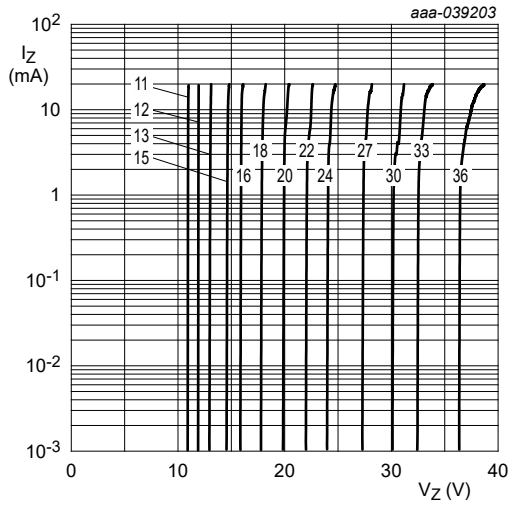
T_{amb} = 25 °C

Fig. 5. Reverse current as a function of reverse voltage; typical values (BZT5250H-B/C1V8-Q to BZT5250H-B/C6V8-Q)



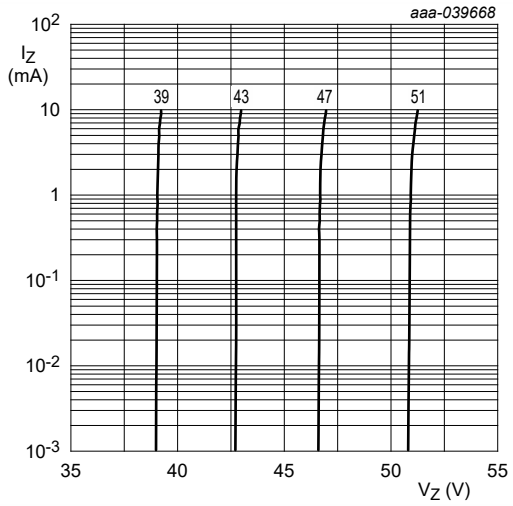
T_{amb} = 25 °C

Fig. 6. Reverse current as a function of reverse voltage; typical values (BZT5250H-B/C7V5-Q to BZT5250H-B/C10-Q)



T_{amb} = 25 °C

Fig. 7. Reverse current as a function of reverse voltage; typical values (BZT5250H-B/C11-Q to BZT5250H-B/C36-Q)



T_{amb} = 25 °C

Fig. 8. Reverse current as a function of reverse voltage; typical values (BZT5250H-B/C39-Q to BZT5250H-B/C51-Q)

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

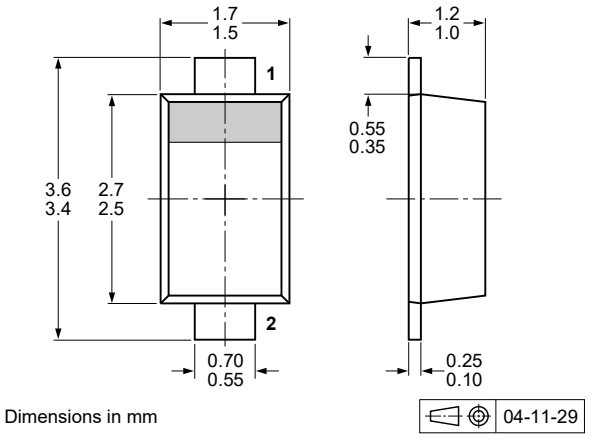
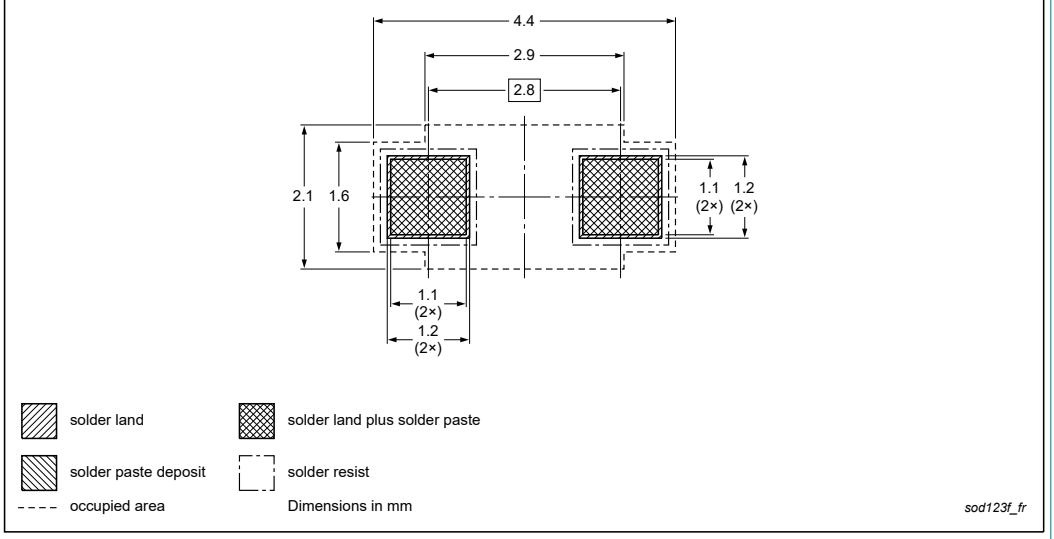


Fig. 9. Package outline SOD123F

13. Soldering



Reflow soldering is the only recommended soldering method.

Fig. 10. Reflow soldering footprint SOD123F

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BZT5250H-Q_SER v.2	20240718	Product data sheet	-	BZT5250H-Q_SER v.1
Modifications:	• Product status changed • Products selections 11 V up to 51 V added			
BZT5250H-Q_SER v.1	20240318	Objective data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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